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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Comparator series

Automotive Ground Sense Comparators

BA2903Yxxx-C, BA2901Yxx-C

General Description

BA2903Yxxx-C/BA2901Yxx-C, integrate two or four independent high gain voltage comparator. Some features are the wide operating voltage that is 2V to 36V and low supply current. BA2903Yxxx-C, BA2901Yxx-C are manufactured for automotive requirements of engine control unit, electric power steering, antilock brake system, etc.

Features

- AEC-Q100 Qualified (Note 1)
- Single or dual supply operation
- Wide operating supply voltage
- Standard comparator Pin-assignments
- Common-mode Input Voltage Range includes ground level, allowing direct ground sensing
- Internal ESD protection circuit
- Wide temperature range (Note1: Grade1)

Application

- Engine Control Unit
- Electric Power Steering (EPS)
- Anti-Lock Brake System (ABS)
- Automotive electronics

Selection Guide

•Key Specifications

Operating supply voltage	
single supply :	+2.0V to +36V
split supply :	±1.0V to ±18V
Supply current	
BA2903Yxxx-C	0.6mA(Typ.)
BA2901Yxx-C	0.8mA(Typ.)
Input bias current :	50nA(Typ.)
Input offset current :	5nA(Typ.)
Operating temperature range :	-40°C to +125°C

•Special Characteristics

Input Offset Voltage	
-40°C to 125°C:	5mV (Max.)

Packages
SOP8

SOP14

MSOP8

SSOP-B8

SSOP-B14

W(Typ.) x D(Typ.) x H(Max.) 5.00mm x 6.20mm x 1.71mm 8.70mm x 6.20mm x 1.71mm 3.00mm x 6.40mm x 1.35mm 5.00mm x 6.40mm x 1.35mm 2.90mm x 4.00mm x 0.90mm



Figure 1. Simplified schematic (one channel only)

OProduct structure : Silicon monolithic integrated circuit OThis product has not designed protection against radioactive rays.

Pin Configuration

BA2903YF-C : SOP8 BA2903YFV-C : SSOP-B8 BA2903YFVM-C : MSOP8



Pin No.	Pin name			
1	OUT1			
2	-IN1			
3	+IN1			
4	VEE			
5	+IN2			
6	-IN2			
7	OUT2			
8	VCC			

BA2901YF-C : SOP14 BA2901YFV-C : SSOP-B14



Pin No.	Pin name			
1	OUT2			
2	OUT1			
3	VCC			
4	-IN1			
5	+IN1			
6	-IN2			
7	+IN2			
8	-IN3			
9	+IN3			
10	-IN4			
11	+IN4			
12	VEE			
13	OUT4			
14	OUT3			

Package									
SOP8 SSOP-B8 MSOP8 SOP14 SSOP-B14									
BA2903YF-C	BA2903YFV-C	BA2903YFVM-C	BA2901YF-C	BA2901YFV-C					

Ordering Information



●Line-up

Topr	Operating Supply Voltage	Dual/Quad	Pa	ackage	Orderable Part Number
	+2.0V to +36V	Dual	SOP8	Reel of 2500	BA2903YF-CE2
			SSOP-B8	Reel of 2500	BA2903YFV-CE2
-40°C to +125°C			MSOP8	Reel of 3000	BA2903YFVM-CTR
		Quad	SOP14	Reel of 2500	BA2901YF-CE2
			SSOP-B14	Reel of 2500	BA2901YFV-CE2

●Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Supply Voltage		VCC-VEE	+36	V	
		SOP8	770 ^{*1*6}		
		SSOP-B8	620 ^{*2*6}		
Power Dissipation	Pd	MSOP8	580 ^{*3*6}	mW	
		SOP14 560 ^{*4*6}			
		SSOP-B14	870 ^{*5*6}		
Differential Input Voltage ^{*7}		Vid	+36	V	
Input Common-mode Voltage Range	Vicm		(VEE-0.3) to (VEE+36)	V	
Input Current ^{*8}		li	-10	mA	
Operating Supply Voltage		Vopr	+2.0 to +36 (±1.0 to ±18)	V	
Operating Temperature Range		Topr	-40 to +125	°C	
Storage Temperature Range		Tstg	-55 to +150	°C	
Maximum junction Temperature		Tjmax	+150	°C	

Note : Absolute maximum rating item indicates the condition which must not be exceeded.

Application if voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

*1 To use at temperature above $Ta=25^{\circ}C$ reduce 6.2mW/°C.

*2 To use at temperature above $Ta=25^{\circ}C$ reduce 5.0mW/°C.

*3 To use at temperature above Ta=25°C reduce 4.7mW/°C.

*4 To use at temperature above Ta=25°C reduce 4.5 mW/°C.

*5 To use at temperature above $Ta = 25^{\circ}C$ reduce 7.0mW/°C.

*6 Mounted on a FR4 glass epoxy PCB(70mm×70mm×1.6mm).

*7 The voltage difference between inverting input and non-inverting input is the differential input voltage.

Then input pin voltage is set to more than VEE.

*8 An excessive input current will flow when input voltages of lesser than VEE-0.6V are applied.

The input current can be set to less than the rated current by adding a limiting resistor.

Electrical Characteristics

OBA2903Yxxx-C (Unless otherwise specified VCC=+5V, VEE=0V)

Deremeter	Cumbol	Temperature	Limits			Linit	Conditions		
Parameter	Symbol	range	Min.	Тур.	Max.	Unit	Conditions		
Input Offect Veltage *9	Vie	25°C	-	2	4	m)/	OUT=1.4V		
input Onset voltage	VIO	Full range	-	-	5	mv	VCC=5 to 36V, OUT=1.4V		
Input Offect Current *9	lia	25°C	-	5	40	5			
Input Oliset Current	10	Full range	-	-	50	ΠA	001=1.4V		
Input Bigg Current *9	lh	25°C	-	50	250	50			
Input bias Current	a	Full range	-	-	275	ΠA	001=1.4V		
Input Common-mode	Viem	25°C	0	-	VCC-1.5	V			
Voltage Range	VICITI	Full range	0	-	VCC-2.0	v	-		
Large Signal Valtage Cain	A.,	25°C	88	100	-	۲ D	VCC=15V, OUT=1.4 to 11.4V		
Large Signal voltage Gain	AV	Full range	74	-	-	αв	RL=15kΩ, VRL=15V		
Supply Current	ICC	25°C	-	0.6	1	mΔ	OUT=open		
Supply Current		Full range	-	-	2.5	mA	OUT=open, VCC=36V		
Output Sink Current *10	Isink	25°C	6	16	-	mΑ	+IN=0V, -IN=1V, VOL=1.5V		
Output Saturation Voltage	VOI	25°C	-	150	400	m\/	+IN=0V, -IN=1V,		
(Low level output voltage)	VOL	Full range	-	-	700	mv	Isink=4mA		
Output Leakage Current	llaak	25°C	-	0.1	-	nA	+IN=1V, -IN=0V, VOH=5V		
(High level output current)	neak	Full range	-	-	1	μA	+IN=1V, -IN=0V, VOH=36V		
				10			RL=5.1kΩ, VRL=5V		
Deenenee Time	Tro	05°C	-	1.3	-		IN=100mV _{P-P} , overdrive=5mV		
Response nine	ne	250		0.4		μs	RL=5.1kΩ, VRL=5V, IN=TTL		
			-	0.4	-		Logic Swing, VREF=1.4V		
Operable Frequency	Foor	25°C	100			kHz	VCC=5V, RL=2kΩ, +IN=1.5V, -IN=5Vp-p		
Operable Frequency	горі	200	100	-	-		(Duty 50% Rectangular Pulse)		

*9 Absolute value

*10 Please determine the output current value in consideration of the power dissipation of the IC under high temperature environment. When the output terminal is continuously shorted, output current may be reduced by the temperature rise of the IC.

OBA2901Yxx-C (Unless otherwise specified VCC=+5V, VEE=0V)

Doromotor	Symbol	Temperature	Limits		Linit	Conditions		
Parameter	Symbol	range	Min.	Тур.	Max.	Unit	Conditions	
Input Offect Veltage *11	Vie	25°C	-	2	4	m\/	OUT=1.4V	
input Onset voltage	VIO	Full range	-	-	5	шv	VCC=5 to 36V, OUT=1.4V	
Input Offect Current *11	lio	25°C	-	5	40	54		
liput Oliset Current	10	Full range	-	-	50	IIA	001=1.4V	
Input Pigg Current *11	lh	25°C	-	50	250	n A		
Input Blas Current	u	Full range	-	-	275	ПА	001=1.4V	
Input Common-mode	Viem	25°C	0	-	VCC-1.5	V		
Voltage Range	VICITI	Full range	0	-	VCC-2.0	v	-	
Largo Signal Voltago Gain	Δ.,	25°C	88	100	-	dB	VCC=15V, OUT=1.4 to 11.4V	
Large Signal Voltage Gain	Av	Full range	74	-	-	uв	RL=15kΩ, VRL=15V	
Supply Current	ICC	25°C	-	0.8	2	mΔ	OUT=open	
		Full range	-	-	2.5	ША	OUT=open, VCC=36V	
Output Sink Current *12	Isink	25°C	6	16	-	mA	+IN=0V, -IN=1V, VOL=1.5V	
Output Saturation Voltage	VOI	25°C	-	150	400	mV	+IN=0V, -IN=1V,	
(Low level output voltage)	VOL	Full range	-	-	700	шv	Isink=4mA	
Output Leakage Current	llook	25°C	-	0.1	-	nA	+IN=1V, -IN=0V, VOH=5V	
(High level output current)	liean	Full range	-	-	1	μA	+IN=1V, -IN=0V, VOH=36V	
				1 0			RL=5.1kΩ, VRL=5V	
Posponso Timo	Tro	25°C	-	1.5	-		IN=100mV _{P-P} , overdrive=5mV	
Response mille	ne	250		0.4		μs	RL=5.1kΩ, VRL=5V, IN=TTL	
			-	0.4	-		Logic Swing, VREF=1.4V	
Operable Frequency	Foor	25°C	100	_	_		VCC=5V, RL=2kΩ, +IN=1.5V, -IN=5Vp-p	
	горі	200	100	-	-	ΝΠΖ	(Duty 50% Rectangular Pulse)	

*11 Absolute value

*12 Please determine the output current value in consideration of the power dissipation of the IC under high temperature environment.

When the output terminal is continuously shorted, output current may be reduced by the temperature rise of the IC.

Description of Electrical Characteristics

Described below are descriptions of the relevant electrical terms used in this datasheet. Items and symbols used are also shown. Note that item name and symbol and their meaning may differ from those on another manufacturer's document or general document.

1. Absolute maximum ratings

Absolute maximum rating items indicate the condition which must not be exceeded. Application of voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

- 1.1 Supply Voltage (VCC-VEE) Indicates the maximum voltage that can be applied between the positive power supply terminal and negative power supply terminal without deterioration or destruction of characteristics of internal circuit.
- 1.2 Differential Input Voltage (Vid) Indicates the maximum voltage that can be applied between non-inverting and inverting terminals without damaging the IC.
- 1.3 Input Common-mode Voltage Range (Vicm) Indicates the maximum voltage that can be applied to the non-inverting and inverting terminals without deterioration or destruction of electrical characteristics. Input common-mode voltage range of the maximum ratings does not assure normal operation of IC. For normal operation, use the IC within the input common-mode voltage range characteristics.
- 1.4 Operating and Storage Temperature Ranges (Topr,Tstg) The operating temperature range indicates the temperature range within which the IC can operate. The higher the ambient temperature, the lower the power consumption of the IC. The storage temperature range denotes the range of temperatures the IC can be stored under without causing excessive deterioration of the electrical characteristics.
- 1.5 Power Dissipation (Pd)

Indicates the power that can be consumed by the IC when mounted on a specific board at the ambient temperature 25°C (normal temperature). As for package product, Pd is determined by the temperature that can be permitted by the IC in the package (maximum junction temperature) and the thermal resistance of the package.

2.Electrical characteristics

2.1 Input Offset Voltage (Vio)

Indicates the voltage difference between non-inverting terminal and inverting terminals. It can be translated into the input voltage difference required for setting the output voltage at 0 V.

2.2 Input Offset Current (lio)

Indicates the difference of input bias current between the non-inverting and inverting terminals.

2.3 Input Bias Current (Ib)

Indicates the current that flows into or out of the input terminal. It is defined by the average of input bias currents at the non-inverting and inverting terminals.

- 2.4 Input Common-mode Voltage Range (Vicm) Indicates the input voltage range where IC normally operates.
- 2.5 Large Signal Voltage Gain (Av) Indicates the amplifying rate (gain) of output voltage against the voltage difference between non-inverting terminal and inverting terminal. It is normally the amplifying rate (gain) with reference to DC voltage. Av = (Output voltage) / (Differential input voltage)
- 2.6 Supply current (ICC) Indicates the current that flows within the IC under specified no-load conditions.
- 2.7 Output Sink Current (Isink) Indicates the current flowing into the IC under specific output conditions.
- 2.8 Output Saturation Voltage (Low level output voltage) (VOL) Indicates the lower limit of output voltage under specific input and output conditions.
- 2.9 Output Leakage Current(High level output current) (Ileak) Indicates the current that flows into the IC under specific input and output conditions.
- 2.11 Response Time (Tre) Indicates the time interval between the application of input and output conditions.
- 2.10 Operable Frequency (Fopr) Indicates minimum frequency that IC moves under specific conditions..

OBA2903Yxxx-C





● Typical Performance Curves - Continued OBA2903Yxxx-C



● Typical Performance Curves - Continued OBA2903Yxxx-C



● Typical Performance Curves - Continued OBA2903Yxxx-C



- Ambient Temperature

Response Time (Low to High) - Over Drive Voltage (VCC=5V, VRL=5V, RL=5.1kΩ)

100



Figure 24. Response Time (High to Low) – Ambient Temperature (VCC=5V, VRL=5V, RL=5.1kΩ)

OBA2901Yxx-C





● Typical Performance Curves - Continued OBA2901Yxx-C



● Typical Performance Curves - Continued OBA2901Yxx-C



 $(\ensuremath{^*})\ensuremath{\mathsf{The}}$ data above is measurement value of typical sample, it is not guaranteed.

● Typical Performance Curves - Continued OBA2901Yxx-C



● Typical Performance Curves - Continued OBA2901 Yxx-C



(*)The data above is measurement value of typical sample, it is not guaranteed.

-25

0

25

50

Figure 47. Response Time (High to Low) – Ambient Temperature (VCC=5V, VRL=5V, RL=5.1kΩ)

AMBIENT TEMPERATURE [°C]

75

100 125 150

-50

Power Dissipation

Power dissipation (total loss) indicates the power that the IC can consume at Ta=25°C (normal temperature). As the IC consumes power, it heats up, causing its temperature to be higher than the ambient temperature. The allowable temperature that the IC can accept is limited. This depends on the circuit configuration, manufacturing process, and consumable power.

Power dissipation is determined by the allowable temperature within the IC (maximum junction temperature) and the thermal resistance of the package used (heat dissipation capability). Maximum junction temperature is typically equal to the maximum storage temperature. The heat generated through the consumption of power by the IC radiates from the mold resin or lead frame of the package. Thermal resistance, represented by the symbol $\theta ja^{\circ}C/W$, indicates this heat dissipation capability. Similarly, the temperature of an IC inside its package can be estimated by thermal resistance.

Figure 50. (a) shows the model of the thermal resistance of the package. The equation below shows how to compute for the Thermal resistance (θ ja), given the ambient temperature (Ta), junction temperature (Tj), and power dissipation (Pd).

 $\theta_{ja} = (T_{jmax}-T_a) / Pd$ °C/W · · · · · (I)

The Derating curve in Figure 48. (b) indicates the power that the IC can consume with reference to ambient temperature. Power consumption of the IC begins to attenuate at certain temperatures. This gradient is determined by Thermal resistance (θ ja), which depends on the chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc. This may also vary even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Figure 49. (c),(d) shows an example of the derating curve for BA2903Yxxx-C, BA2901Yxx-C.







(*13)	(*14)	(*15)	(*16)	(*17)	UNIT
6.2	5.0	4.7	7.0	4.5	mW/°C

When using the unit above Ta=25°C, subtract the value above per degree°C.

Permissible dissipation is the value when FR4 glass epoxy board 70mm×70mm×1.6mm(cooper foil area below 3%) is mounted.

Figure 49. Derating curve

•Application Information

NULL method condition for Test circuit 1

VCC,VEE,EK,Vicm Unit : V

Parameter	VF	S1	S2	S3	VCC	VEE	EK	Vicm	Calculation
Input Offset Voltage	VF1	ON	ON	ON	5~36	0	-1.4	0	1
Input Offset Current	VF2	OFF	OFF	ON	5	0	-1.4	0	2
	VF3	OFF	ON	ON	5	0	-1.4	0	0
Input bias Current	VF4	ON	OFF		5	0	-1.4	0	3
Larga Signal Valtaga Gain	VF5		ON ON		15	0	-1.4	0	4
Large Signal Vollage Gall	VF6			ON	15	0	-11.4	0	

- Calculation -

1. Input Offset Voltage (Vio)

$$Vio = \frac{|VF1|}{1 + RF / RS} [V]$$

2. Input Offset Current (lio)

$$\mathsf{lio} = \frac{|\mathsf{VF2} - \mathsf{VF1}|}{\mathsf{Ri} \times (\mathsf{1} + \mathsf{RF} / \mathsf{RS})} \quad [\mathsf{A}]$$

3. Input Bias Current (Ib)

$$Ib = \frac{|VF4 - VF3|}{2 \times Ri \times (1 + RF/RS)} [A]$$

4. Large Signal Voltage Gain (Av)

$$Av = 20 \times Log \frac{\Delta EK \times (1 + RF/RS)}{|VF5 - VF6|} \quad [dB]$$



Figure 50. Test circuit 1 (one channel only)

BA2903Yxxx-C, BA2901Yxx-C

SW No.		SW 1	SW 2	SW 3	SW 4	SW 5	SW 6	SW 7
Supply Current		OFF						
Output Sink Current	VOL=1.5V	OFF	ON	ON	OFF	OFF	OFF	ON
Output Saturation Voltage	lsink=4mA	OFF	ON	ON	OFF	ON	ON	OFF
Output Leakage Current	VOH=36V	OFF	ON	ON	OFF	OFF	OFF	ON
Response Time	RL=5.1kΩ, VRL=5V	ON	OFF	ON	ON	OFF	OFF	OFF



Figure 51. Test Circuit 2 (one channel only)





• Application example

OReference voltage is -IN



While the input voltage(Vin) is higher that the reference voltage, the output voltage remains high. In case the input voltage becomes lower than the reference voltage, the output voltage will turn low.



OReference voltage is +IN



While the input voltage(Vin) is smaller that the reference voltage, the output voltage remains high. In case the input voltage becomes higher than the reference voltage, the output voltage will turn low.



Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

Operational Notes –Continued

11. Unused circuits

When there are unused comparators, it is recommended that they are connected as in Figure 53. ,setting the non-inverting input terminal to a potential within the in-phase input voltage range (Vicm).







12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.



13. Ceramic Capacitor

When using a ceramic capacitor, determine the dielectric constant considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

14. Input voltage

Applying VEE +36V to the input terminal is possible without causing deterioration of the electrical characteristics or destruction, regardless of the supply voltage. However, this does not ensure normal circuit operation. Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.

15. Power supply (single / split)

The comparator operates when the voltage supplied is between VCC and VEE. Therefore, the single supply comparator can be used as a split supply comparator as well.

16. Terminal short-circuits

When the output and VCC terminals are shorted, excessive output current may flow, resulting in undue heat generation and, subsequently, destruction.

17. IC handling

Applying mechanical stress to the IC by deflecting or bending the board may cause fluctuations in the electrical characteristics due to piezo resistance effects.

Physical Dimension, Tape and Reel Information



